

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Je-Kyun PARK	05/24/2010
Joo-Hun KANG	05/24/2010
Sung-Young CHOI	05/25/2010
Won-Hye LEE	05/25/2010
Hee Sang YOON	05/21/2010
RECEIVING PARTY DATA	
Name:	Korea Advanced Institute of Science and Technology
Street Address:	373-1 Guseong-dong, Yuseong-gu
City:	Daejeon
State/Country:	REPUBLIC OF KOREA
Postal Code:	305-701
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12746730
CORRESPONDENCE DATA	
Fax Number:	(617)742-4214
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	617-227-7400
Email:	lc@lahive.com
Correspondent Name:	LAHIVE & COCKFIELD, LLP FLOOR 30, SUITE
Address Line 1:	ONE POST OFFICE SQUARE
Address Line 4:	BOSTON, MASSACHUSETTS 02109
ATTORNEY DOCKET NUMBER:	WN7-018US
NAME OF SUBMITTER:	EuiHoon Lee

CH \$40.00 12746730

Total Attachments: 2

source=WN7_Assignment#page1.tif

source=WN7_Assignment#page2.tif

ASSIGNMENT BY INVENTORS

We, PARK, Je-Kyun; KANG, Joo-Hun; CHOI, Sung-Young and LEE, Won-Hye of Daejon, Republic of Korea; Seoul, Republic of Korea; Gyeonggi-do, Republic of Korea and Busan, Republic of Korea, respectively, in consideration of One Dollar and other valuable consideration paid to us by

KOREA ADVANCED INSTITUTE OF SCIENCE AND TECHNOLOGY

a corporation of Republic of Korea, having its principal place of 373-1 Guseong-dong, Yuseong-gu, Daejon 305-701, the receipt of which is hereby acknowledged, do hereby sell, assign and transfer unto said

KOREA ADVANCED INSTITUTE OF SCIENCE AND TECHNOLOGY

its successors and assigns, the entire interest for the United States of America and all foreign countries including all rights of priority under the International Convention for the Protection of Industrial Property in a certain invention or improvement in

APPARATUS, MICROFLUIDIC CHIP AND METHOD FOR SEPARATING PARTICLES USING ISOMAGNETOPHORESIS

described in an application

Executed by us of even date herewith and about to be filed

or

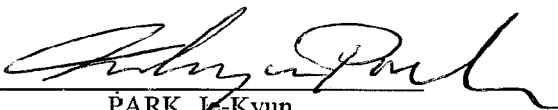
Application No. _____, filed on _____

in the United States Patent and Trademark Office, and in all Letters Patent of the United States and all foreign countries which may or shall be granted on said invention, or any parts thereof, or on said application, or any divisional, continuing, reissue or other applications based in whole or in part thereon. And we agree, for ourselves and our executors and administrators, with said Institute and its successors and assigns but at its or their expense and charges, hereafter to execute all applications, amended specifications, deed or other instrument, and to do all acts necessary or proper to secure the grant of Letters Patent in the United States and in all other countries to said corporation, with specifications and claims in such form as shall be approved by the counsel of said Institute and to vest and confirm in said Institute, its successors and assigns, the legal title to all such patents.

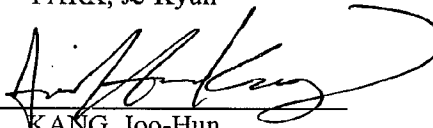
And we do hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue such Letters Patent as shall be granted upon said application or applications based thereon to said Institute, its successors and assigns.

And we do further hereby grant the attorneys/agents of Lahive & Cockfield, LLP, the power to insert on this Assignment the filing date and/or application number of said application.

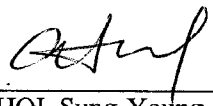
5/24/2010
Date


PARK, Je-Kyun

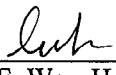
5/24/2010
Date


KANG, Joo-Hun

5/25/2010
Date


CHOI, Sung-Young

5/25/2010
Date


LEE, Won-Hye

Witness:

5/27/2010
Date


YOON, Hee Sang